

### **Product Change Notification / SYST-17FIJY567**

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18-Mar-2022

## **Product Category:**

32-bit Microcontrollers

## **PCN Type:**

**Document Change** 

## **Notification Subject:**

ERRATA - SAM L10/L11 Family Silicon Errata and Data Sheet Clarification Document Revision

## **Affected CPNs:**

SYST-17FIJY567\_Affected\_CPN\_03182022.pdf SYST-17FIJY567\_Affected\_CPN\_03182022.csv

### **Notification Text:**

SYST-17FIJY567

Microchip has released a new Product Documents for the SAM L10/L11 Family Silicon Errata and Data Sheet Clarification of devices. If you are using one of these devices please read the document located at SAM L10/L11 Family Silicon Errata and Data Sheet Clarification.

**Notification Status: Final** 

#### **Description of Change:**

- 1) Updated the device ID in SAM L10 Family Silicon Device Identification.
- 2) The following errata were added in this revision:
  - a) ADC: 2.1.3 SEQSTATE
  - b) NVMCTRL: 2.22.2 Random Hardfaults in Waking

Impacts to Data Sheet: None

Reason for Change: To Improve Productivity

**Change Implementation Status: Complete** 

**Date Document Changes Effective:** 18 Mar 2022

<b>NOTE:</b> Please be advised that this is a change to the document only the product has not been changed.
Markings to Distinguish Revised from Unrevised Devices: N/A
Attachments:
SAM L10/L11 Family Silicon Errata and Data Sheet Clarification

Please contact your local Microchip sales office with questions or concerns regarding this notification.

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# SYST-17FIJY567 - ERRATA - SAM L10/L11 Family Silicon Errata and Data Sheet Clarification Document Revision

### Affected Catalog Part Numbers(CPN)

ATSAML10D14A-YF

ATSAML10D15A-YF

ATSAML10D16A-YF

ATSAML10D14A-MF

ATSAML10D15A-MF

ATSAML10D16A-MF

ATSAML10E16A-MZ

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ATSAML10E15A-MZ

ATSAML10E14A-MF

ATSAML10E15A-MF

ATSAML10E16A-MF

ATSAML10E16A-AZ

ATSAML10E15A-AZ

ATSAML10E14A-AF

ATSAML10E15A-AF

ATSAML10E16A-AF

ATSAML10D16A-MZ

ATSAML10D15A-MZ

ATSAML10D14A-YU

ATSAML10D15A-YU

ATSAML10D16A-YU

ATSAML10D14A-MU

ATSAML10D15A-MU

ATSAML10D16A-MU

ATSAML10E14A-MU

ATSAML10E15A-MU

ATSAML10E16A-MU

ATSAML10E14A-AU

ATSAML10E15A-AU

ATSAML10E16A-AU

ATSAML10E14A-UUT

ATSAML10E15A-UUT

ATSAML10E16A-UUT

ATSAML10D14A-YUT

ATSAML10D15A-YUT

ATSAML10D16A-YUT

ATSAML10D14A-MUT

ATSAML10D15A-MUT

ATSAML10D16A-MUT

ATSAML10E14A-MUT

ATSAML10E15A-MUT

ATSAML10E16A-MUT

ATSAML10E14A-AUT

ATSAML10E15A-AUT

ATSAML10E16A-AUT

ATSAML10D14A-YFT

ATSAML10D15A-YFT

ATSAML10D16A-YFT

ATSAML10D14A-MFT

ATSAML10D15A-MFT

ATSAML10D16A-MFT

ATSAML10E16A-MZT

ATSAML10E15A-MZT

ATSAML10E16A-MZTV02

ATSAML10E14A-MFT

ATSAML10E15A-MFT

ATSAML10E16A-MFT

ATSAML10E16A-AZT

ATSAML10E15A-AZT

ATSAML10E14A-AFT

ATSAML10E15A-AFT

ATSAML10E16A-AFT

ATSAML10D16A-MZT

ATSAML10D15A-MZT

ATSAML10D16A-MZTV01

ATSAML10D16A-MZTVAO

ATSAML11D14A-YF

ATSAML11D15A-YF

ATSAML11D16A-YF

ATSAML11D14A-MF

ATSAML11D15A-MFKPH

ATSAML11D15A-MF

ATSAML11D16A-MFKPH

ATSAML11D16A-MF

ATSAML11E15A-MZ

ATSAML11E16A-MZ

ATSAML11E16A-MF

ATSAML11E16A-MFKPH

ATSAML11E14A-MF

ATSAML11E15A-MFKPH

ATSAML11E15A-MF

ATSAML11E15A-AZ

ATSAML11E16A-AZ

ATSAML11E14A-AF

ATSAML11E15A-AFKPH

ATSAML11E15A-AF

ATSAML11E16A-AFKPH

ATSAML11E16A-AF

ATSAML11D15A-MZ

ATSAML11D16A-MZ

ATSAML11D14A-YU

ATSAML11D15A-YU

ATSAML11D16A-YU

ATSAML11D14A-MU

ATSAML11D15A-MUKPH

ATSAML11D15A-MU

ATSAML11D16A-MUKPH

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ATSAML11E15A-MUKPH

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ATSAML11E16A-MU

ATSAML11E14A-AU

ATSAML11E15A-AUKPH

ATSAML11E15A-AU

ATSAML11E16A-AUKPH

ATSAML11E16A-AU

ATSAML11E14A-UUT

ATSAML11E15A-UUT

ATSAML11E16A-UUT

ATSAML11D14A-YUT

ATSAML11D15A-YUT

ATSAML11D16A-YUT

ATSAML11D14A-MUT

ATSAML11D15A-MUTKPH

ATSAML11D15A-MUT

ATSAML11D16A-MUTKPH

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ATSAML11E14A-MUT

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ATSAML11D16A-YFT

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ATSAML11D15A-MFTKPH

ATSAML11D15A-MFT

ATSAML11D16A-MFTKPH

ATSAML11D16A-MFT

ATSAML11E15A-MZT

ATSAML11E16A-MZT

ATSAML11E16A-MZTVAO

ATSAML11E14A-MFT

ATSAML11E15A-MFTKPH

ATSAML11E15A-MFT

ATSAML11E16A-MFTKPH

ATSAML11E16A-MFT

ATSAML11E15A-AZT

ATSAML11E16A-AZT

ATSAML11E14A-AFT

ATSAML11E15A-AFTKPH

ATSAML11E15A-AFT

ATSAML11E16A-AFTKPH

ATSAML11E16A-AFT

ATSAML11D15A-MZT

ATSAML11D16A-MZT

# SAM L10/L11 Family

## Silicon Errata and Data Sheet Clarification

## SAM L10/L11 Family

The SAM L10/L11 family of devices that you have received conform functionally to the current Device Data Sheet (DS60001513G), except for the anomalies described in this document.

The silicon issues discussed in the following pages are for silicon revisions with the Device and Revision IDs listed in the following tables. The silicon issues are summarized in the Silicon Issue Summary.

The errata described in this document will be addressed in future revisions of the SAM L10/L11 family silicon.

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current.

Data Sheet clarifications and corrections (if applicable) are located in 3. Data Sheet Clarifications, following the discussion of silicon issues.

**Table 1. SAM L10 Family Silicon Device Identification** 

Part Number	Device ID (DID[31:0])	Revision (DID.REVISION[3:0])
r art Names	טפאוכפ ט (ני. ו גןטוטן) טו	В
SAML10E16A	0x20840x00	
SAML10E15A	0x20840x01	
SAML10E14A	0x20840x02	0x1
SAML10D16A	0x20840x03	UAT
SAML10D15A	0x20840x04	
SAML10D14A	0x20840x05	

Table 2. SAM L11 Family Silicon Device Identification

Part Number	Device ID (DID[31:0])	Revision (DID.REVISION[3:0])
r art Number	טופאוכפ (ני. ו גןטוט) טו	В
SAML11E16A	0x20830x00	
SAML11E15A	0x20830x01	
SAML11E14A	0x20830x02	0x1
SAML11D16A	0x20830x03	UA I
SAML11D15A	0x20830x04	
SAML11D14A	0x20830x05	

**Note:** Refer to the "Device Service Unit" chapter in the current Device Data Sheet (DS60001513G) for a detailed information on Device Identification and Revision IDs for your specific device.

## **Table of Contents**

SA	M L10/l	L11 Family	1
1.	Silicor	n Issue Summary	3
2.	SAM I	L10/L11 Errata Issues	8
	2.1.	Analog-to-Digital Converter (ADC)	8
	2.2.	Configurable Custom Logic (CCL)	
	2.3.	DEVICE	10
	2.4.	Direct Memory Access Controller (DMAC)	10
	2.5.	External Interrupt Controller (EIC)	11
	2.6.	Frequency Meter (FREQM)	11
	2.7.	Main Clock (MCLK)	11
	2.8.	Operational Amplifier Controller (OPAMP)	12
	2.9.	Real Time Clock (RTC)	13
	2.10.	Serial Communication Interface Inter-Integrated Circuit (SERCOM I <sup>2</sup> C)	17
	2.11.	Serial Communication Serial Peripheral Interface (SERCOM SPI)	20
	2.12.	Serial Communication Interface USART (SERCOM USART)	21
	2.13.	Timer Counter (TC)	23
	2.14.	True Random Number Generator (TRNG)	24
	2.15.	Supply Controller (SUPC)	25
	2.16.	OSC32KCTRL	25
	2.17.	Boot ROM	27
	2.18.	Event System (EVSYS)	27
	2.19.	Oscillator Controller (OSCCTRL)	29
		PORT I/O Controller (PORT)	
		Trust Ram (TRAM)	
	2.22.	Non Volatile Memory Controller (NVMCTRL)	31
3.	Data S	Sheet Clarifications	33
4.	Revisi	ion History	34
The	Micro	chip Web Site	36
Cu	stomer	Change Notification Service	36
Cu	stomer	Support	36
Mic	rochip	Devices Code Protection Feature	36
Leç	jal Noti	ce	37
Tra	demark	Ks	37
Qua	ality Ma	anagement System Certified by DNV	37
Wo	rldwide	e Sales and Service	38

# 1. Silicon Issue Summary

Table 1-1. Silicon Issue Summary

Module Feature		Errata Number	Summary	Device	Affected Silicon Revisions		
					В		
ADC	Reference Buffer Offset	2.1.1	First ADC conversions are incorrect when using Reference Buffer Offset	SAM L10	Х		
ADC	Compensation	2.1.1	Compensation.	SAM L11	X		
ADC	Offset Correction	2.1.2	Offset correction is not supported in the 8-bit and 10-bit conversion	SAM L10	X		
7.50	0.1001.001.001.		resolution.	SAM L11	X		
ADC	SEQSTATE	2.1.3	The SEQSTATUS synchronization is not managed properly when the system comes out of standby mode, leading to a wrong SEQSTATE value	SAM L10	X		
ADC	SEGSTATE	2.1.5	read in the first SEQSTATUS update of the sequence.	SAM L11	X		
001	DAC mesta etian	2.2.4	Writing the Software Reset bit in the Control A register will trigger a PAC	SAM L10	Х		
CCL	PAC protection	2.2.1	protection error.	SAM L11	X		
001	Enable-protected	2.2.2	The SEQCTRL0 and LUCTRL0/1 registers are enable-protected by the	SAM L10	Х		
CCL	Registers	2.2.2	CTRL.ENABLE bit.	SAM L11	X		
001	Compostial logic	2.2.2	LUT Output is commented offer enabling CCL when acquantial legis is used	SAM L10	Х		
CCL	Sequential logic	2,2,3	LUT Output is corrupted after enabling CCL when sequential logic is used.		Х		
Dovice	Tomporatura consor	2.3.1	Temperature sensor is not functional.	SAM L10	Х		
Device	evice Temperature sensor		remperature sensor is not functional.	SAM L11	Х		
Dovice	Device Standby Entry	Standby Entry	vice Standby Entry	2.3.2	Potential hard fault upon standby entry when Systick interrupt is enabled	SAM L10	Х
Device		2.5.2	rotential flate fault upon standay entry when systick interrupt is enabled	SAM L11	X		
DMAC	Concurrent Channels	2.4.1	When using concurrent channel triggers, DMA write-back descriptors may	SAM L10	X		
DIVIAC	Trigger	2.4.1	get corrupted.	SAM L11	Х		
FIG	DAGt	0.5.4	8-bit and 16-bit reads/writes on the reserved areas of the EIC registers	SAM L10	X		
EIC	PAC protection	2.5.1	mapping starting from EVCTRL register do not generate a PAC protection error.	SAM L11	X		
				SAM L10	Х		
FREQM	PAC protection	2.6.1	FREQM reads on the Control B register generate a PAC protection error.	SAM L11	Х		
140114	D40	074	Writes to the MCLK Control A register do not generate a PAC protection	SAM L10	Х		
MCLK	PAC protection	2.7.1	error even if this register has been write-protected using the PAC.	SAM L11	Х		
MOUL	DELLUI D. L. I.	0.7.0		SAM L10	Х		
MCLK	DFLLULP clock	2.7.2	Hardfault exception after having selected DFLLULP clock as main clock.	SAM L11	Х		
OBAMB	Potorones huffer	2.0.4	The internal reference REFBUF is not generated when the voltage doubler	SAM L10	Х		
OPAMP	Reference buffer	2.8.1	is disabled.	SAM L11	Х		
OPAMP	High Gain	2.9.2	High Coin Instrumentation Amelification as functional	SAM L10	Х		
OPAMP	Instrumentation Amplifier	2.8.2	High Gain Instrumentation Amplifier is not functional.		Х		
DTO	Tompor datastics	204	Tomogradatedian limitation when OTRLD CERTO = 0	SAM L10	Х		
RTC	Tamper detection	2.9.1	Tamper detection limitation when CTRLB.SEPTO = 0.	SAM L11	Х		
DTO	Event generation	Periodic Daily Event (PERD) Event Generator never occurs in Clock/	Periodic Daily Event (PERD) Event Generator never occurs in Clock/	SAM L10	Х		
RTC	Event generation	2.9.2	Calendar mode.	SAM L11	Х		

RTC   Minte corruption   2.9.3   RTC COUNT and CLOCK registers write corruption.   SAM LT0   X	continued						
RTC   Tamper Detection Timestamp   2.9.4   If an external reset occurs during a tamper detection, the TIMESTAMP register will not be updated when next tamper detection, the TIMESTAMP register will not be updated when next tamper detection, the TIMESTAMP register will not be updated when next tamper detection, the TIMESTAMP register will not be updated when next tamper detection, the TIMESTAMP personal reset of the Charles	Module	Feature		Summary	Device	Silicon Revisions	
Tamper Detection Timestamp  RTC  Prescaler  2.9.4  If an external reset occurs during a tamper detection, the TIMESTAMP register will not be updated when next tamper detection is triggered.  RTC  Prescaler  2.9.5  When the tamper of debotion is triggered.  RTC  Active Layer Protection  2.9.6  Active Layer Protection feature is limited to one tamper channel in (i.e. one RTC INNOUTh pair).  RTC  Tamper Detection  Timestamp  2.9.7  The INTFLAG.TAMPER bit is not seet by reading the TIMESTAMP register.  RTC  Tamper Detection  Timestamp  2.9.8  A wrong timestamp value can be returned if more than non-OPU and DMA accesses to the TIMESTAMP register.  RTC  Tamper Detection  Timestamp  2.9.9  A wrong timestamp value can be returned if more than non-OPU and DMA accesses to the TIMESTAMP register are performed upon a NTFLAG.TAMPER assertion.  RTC  Tamper Detection  2.9.9  If the Tamper Channel n-Action is set to WAKE or CAPTURE and the Active Layer Protection is enable for this channel, no tampers are detected on this channel.  RTC  General Purpose Registers  2.9.11  General Purpose Registers in (GPI) are reset on tamper detection even if GPTRST = 0.  XAM L10  X SAM L1	RTC	Write corruption	2.9.3	RTC COUNT and CLOCK registers write corruption.	SAM L10	Х	
Timestamp 2.9.4 In the catemater seed of course to string is alrapte obsected. He in the catemater seed of the categories of the projects will not be updated when the categories in Singerout.  RTC Prescular 2.9.5 When the tamper of debouncing features (TAMPCTRL) are enabled periodic interrupts and events are generated when the prescular is SAM L10 X SAM L11 X SAM					SAM L11	Х	
Prescaler  2.9.5  When the tamper or debouncing features (TAMPCTRL) are enabled, periodic interrupts and events are generated when the prescaler is OFF (CTRLA-PRESALER-Po).  Active Layer Protection  2.9.6  Active Layer Protection  Tamper Detection Timestamp  2.9.7  Tamper Detection Timestamp  2.9.8  Active Layer Protection feature is limited to one tamper channel in (i.e. one RTC INn/OUTn pair).  Active Layer Protection Timestamp  2.9.7  Tamper Detection Timestamp  2.9.8  A wrong limestamp value can be returned if more than one CPU and DMA accesses to the TIMESTAMP register are performed upon a INTFLAG.TAMPER ascite.  Active Layer Protection is enabled for this channel, no tampers are detected on this channel in.  RTC  Tamper Detection  2.9.9  If the Tamper Detection senabled for this channel, no tampers are detected on this channel in.  RTC  General Purpose Registers  2.9.11  General Purpose Registers in (GPh) are reset on tamper detection even if GPTRST = 0.  Active Layer Protection 2.9.12  When the RTC is configured in Active Layer Protection mode (TAMPCTRLINACT = 0x) and the RTC CTRLA-ENABLE bit is not set, a tamper can be detected and a timestamp captured. The TAMPED register are shorted to the configuration of the CTC TRLA-ENABLE bit is not set, a tamper can be detected and a timestamp captured. The TAMPED register and the SAML10  X  SERCOM PC  Repeated stant / Host mode 10-bit  2.10.2  Bus error is generated during a Repeated Start (when QCEN = 1 and SAML10  X  SERCOM PC  Repeated Stant / Host mode 10-bit  Repeated Stant in 10-bit addressing mode for Host Write operations does not work.  SERCOM PC  Client mode 10-bit  2.10.5  Bus error is generated during a Repeated Start (when QCEN = 1 and SAML10  X  SAML11  X  SERCOM PC  Repeated Stant / Host mode 10-bit  Character lost in PC Client mode with DMA when a NACK occurs.  SAML11  X  SERCOM PC  Client mode 10-bit  2.10.5  Bus Error is PC Client mode with DMA when a NACK occurs.  SAML11  X  SAML10  X  SAML10  X  SAML10  X  SAML10  X  SAML10  X  SAML10  X  SAM	RTC	'	2.9.4	9 ,	SAM L10	X	
Prescaler  Prescaler  2.9.5 periodic interrupts and events are generated when the prescaler is OFF (CTRLA PRESCALER-0).  Active Layer Protection  2.9.6 Active Layer Protection feature is limited to one tamper channel in (i.e. one NTC INn/OUTh pair).  Active Layer Protection feature is limited to one tamper channel in (i.e. one NTC INn/OUTh pair).  Active Layer Protection feature is limited to one tamper channel in (i.e. one NTC INn/OUTh pair).  Active Layer Protection feature is limited to one tamper channel in (i.e. one NTC INN/OUTh pair).  Active Layer Protection feature is limited to one tamper channel in (i.e. one NTC INN/OUTh pair).  Advice Layer Protection feature is limited to one tamper channel in (i.e. one NTC INN/OUTh pair).  Active Layer Protection feature is limited to one tamper channel in (i.e. one NTC INN/OUTh pair).  Advice Layer Protection feature is limited to one tamper channel in (i.e. one NTC INN/OUTh pair).  Active Layer Protection feature is limited to one tamper channel in (i.e. one NTC INN/OUTh pair).  Active Layer Protection feature is limited to one tamper channel in (i.e. one NTC INN/OUTh pair).  Active Layer Protection feature is limited to one tamper channel in (i.e. one NTC INN/OUTh pair).  Active Layer Protection feature is set to MARE or CAPTURE and the Active Layer Protection is analysed for this channel in.  Active Layer Protection feature is set to MARE or CAPTURE and the Active Layer Protection in one Active Layer Protection in one of CAPTURE and the Active Layer Protection one in tamper detection even in GPTRT - 0.  Active Layer Protection feature is set to MARE or CAPTURE and the Active Layer Protection mode (INN/OUTh pair).  Active Layer Protection feature is set to MARE or CAPTURE and the Active Layer Protection mode (INN/OUTh pair).  Active Layer Protection feature in the NTC or configured in Active Layer Protection mode (INN/OUTh pair).  Active Layer Protection feature in the NTC or configured in Active Layer Protection mode (INN/OUTh pair).  Active Layer Protection fe		Timestamp		register will not be updated when next tamper detection is triggered.	SAM L11	Х	
RTC Active Layer Protection 2.9.6 Active Layer Protection contamper channel in (i.e. one RTC InviGUTI pair).  RTC Tamper Detection Timestamp 2.9.7 The INTFLAG.TAMPER bit is not reset by reading the TIMESTAMP SAM L10 X SAM L11 X SAM L11 X SAM L11 X SAM L10	RTC	Prescaler	295		SAM L10	X	
Active Layer Protection Timestamp 2.9.5 The INTFLAG.TAMPER bit is not reset by reading the TIMESTAMP register.  Tamper Detection Timestamp 2.9.8 The INTFLAG.TAMPER bit is not reset by reading the TIMESTAMP register.  A wrong timestamp value can be returned if more than one CPU and DMA accesses to the TIMESTAMP register are performed upon an INTFLAG.TAMPER assertion.  A wrong timestamp value can be returned if more than one CPU and DMA accesses to the TIMESTAMP register are performed upon an INTFLAG.TAMPER assertion.  A wrong timestamp value can be returned if more than one CPU and DMA accesses to the TIMESTAMP register are performed upon an INTFLAG.TAMPER assertion.  A wrong timestamp value can be returned if more than one CPU and DMA accesses to the TIMESTAMP register are performed upon an INTFLAG.TAMPER assertion.  A wrong timestamp value can be returned if more than one CPU and DMA accesses to the TIMESTAMP register are performed upon an INTFLAG.TAMPER assertion.  A wrong timestamp value can be returned if more than one CPU and DMA accesses to the TIMESTAMP register are performed upon an INTFLAG.TAMPER assertion.  A wrong timestamp value can be returned if more than one CPU and DMA accesses to the TIMESTAMP register are performed upon and DMA accesses to the TIMESTAMP register are performed upon and DMA accesses to the TIMESTAMP register are performed upon and DMA accesses to the TIMESTAMP register are performed upon and DMA accesses to the TIMESTAMP register are performed upon and DMA accesses to the TIMESTAMP register are performed upon and DMA accesses to the TIMESTAMP register are performed upon and DMA accesses to the TIMESTAMP register are performed upon and DMA accesses to the TIMESTAMP register are performed upon and DMA accesses to the TIMESTAMP register are performed upon and DMA accesses to the TIMESTAMP register are performed upon and DMA accesses to the TIMESTAMP register are performed upon and DMA accesses to the TIMESTAMP register are performed upon and DMA accesses to the TIMESTAMP register a				1	SAM L11	X	
RTC Tamper Detection Timestamp 2.9.7 The INTELAG.TAMPER bit is not reset by reading the TIMESTAMP SAM L10 X SAM L11 X AND TIMESTAMP register.  RTC Tamper Detection Timestamp 2.9.8 A wrong timestamp value can be returned if more than one CPU and DMA accesses to the TIMESTAMP register are performed upon an INTELAG.TAMPER assertion.  RTC Tamper Detection 2.9.9 If the Tamper Cheneric Action is enabled for this channel, no tampers are detected on this channel, no tampers are detected on this channel in.  RTC Tamper Detection 2.9.10 False tamper detections may occur when configuring the RTC INn and CUTn pins.  RTC General Purpose Registers 2.9.11 General Purpose Registers in (GPn) are reset on tamper detection even if GPTRST = 0.  When the RTC is configured in Active Layer Protection move and the RTC STEALABLE bit is not set, a tamper can be detected and a timestamp captured. The TAMPID register and INTELAG.TAMPER bit may not be set.  SERCOM I <sup>2</sup> C High-speed mode 2.10.1 When configured in HS or Fast-Mode Plus. SDA and SCL fall times are shorter than I <sup>2</sup> C specification requirement and can lead to reflection.  SERCOM I <sup>2</sup> C Repeated start 2.10.2 Bus error is generated during a Repeated Start (when QCEN = 1 and SCLSM = 1).  SERCOM I <sup>2</sup> C Repeated Start / Host mode 10-bit 2.10.4 Repeated Start is not supported for High-Speed mode Host Read operations.  SERCOM I <sup>2</sup> C Client Mode with DMA 2.10.6 Character lost in I <sup>2</sup> C Client thode with DMA when a NACK occurs.  SAM L10 X  SAM L11 X  SAM L11 X  SAM L11 X  SAM L10 X  SAM L11 X  SA	PTC	Active Layer Protection	206	Active Layer Protection feature is limited to one tamper channel n (i.e. one	SAM L10	X	
TITE TITE AND TO TITE AND TO THE INTERIOR AND TO TREASE BY Peading the Times and Times	RIC	Active Layer Frotection	2.9.0	RTC INn/OUTn pair).	SAM L11	Х	
Tamper Detection Timestamp	PTC	Tamper Detection	207	The INTFLAG.TAMPER bit is not reset by reading the TIMESTAMP	SAM L10	Х	
ACTIVE SERCOM IPC Repeated Start / Host mode 10-bit RTC	KIO	Timestamp	2.5.1	register.	SAM L11	X	
Timestamp	DTO	Tamper Detection		,	SAM L10	Х	
Tamper Detection  2.9.9 Active Layer Protection is enabled for this channel, no tampers are detected on this channel in.  Tamper Detection  2.9.10 False tamper detections may occur when configuring the RTC INn and OUTn pins.  SAM L11 X	RTC		2.9.8	, , ,	SAM L11	Х	
RTC Tamper Detection 2.9.10 False tamper detections may occur when configuring the RTC INn and OUTn pins.  RTC General Purpose Registers (GPn) are reset on tamper detection even if GPTRST = 0.  When the RTC is configured in Active Layer Protection mode (TAMPCTRLINARCT = 0x3) and the RTC CTRLAENABLE bit is not set, a tamper can be detected and a timestamp captured. The TAMPID register and INTFLAC.TAMPER bit may not be set.  SERCOM IPC High-speed mode 2.10.1 When configured in HS or Fast-Mode Plus, SDA and SCL fall times are shorter than IPC specification requirement and can lead to reflection.  SERCOM IPC Repeated Start / Host mode 10-bit 2.10.3 Repeated Start in 10-bit addressing mode for Host Write operations does not work.  SERCOM IPC Repeated Start / Host mode 10-bit 2.10.5 Repeated Start is not supported for High-Speed mode Host Read operations.  SERCOM IPC Client mode with DMA 2.10.6 Character lost in IPC Client mode with DMA when a NACK occurs.  SERCOM IPC Client mode 10-bit 2.10.7 PC Client 10-bit addressing mode is not functional.  SERCOM IPC Client mode 10-bit 2.10.8 BUSERR, COLL, LOWTOUT, SEXTOUT and LENERR Status register SAM L10 X  SAM L10 X  SAM L11 X  SAM	DTC	Tamper Detection	200	· ·	SAM L10	X	
RTC   Tamper Detection   2.9.10   Prates lamper detections in any occur when the OIIT pins.   SAM L11   X    RTC   General Purpose   Registers   2.9.11   General Purpose Registers in (GPn) are reset on tamper detection even if GPTRST = 0.   SAM L11   X    RTC   Active Layer Protection   2.9.12   When the RTC is configured in Active Layer Protection mode   SAM L11   X    SERCOM I <sup>2</sup> C   High-speed mode   2.10.1   When configured in Active Layer Protection and INTFLAC. TAMPER bit may not be set.   SAM L11   X    SERCOM I <sup>2</sup> C   Repeated start   2.10.2   When configured in HS or Fast-Mode Plus, SDA and SCL fall times are shorter than I <sup>2</sup> C specification requirement and can lead to reflection.   SAM L11   X    SERCOM I <sup>2</sup> C   Repeated start   2.10.2   Bus error is generated during a Repeated Start (when OCEN = 1 and SCLSM = 1).   SAM L11   X    SERCOM I <sup>2</sup> C   Repeated Start / Host mode 10-bit   2.10.3   Repeated Start in 10-bit addressing mode for Host Write operations does not work.   SAM L11   X    SERCOM I <sup>2</sup> C   Repeated Start / Host mode 10-bit   2.10.4   Repeated Start is not supported for High-Speed mode Host Read operations.   SAM L11   X    SERCOM I <sup>2</sup> C   Repeated Start / High-Speed mode   2.10.5   Repeated Start is not supported for High-Speed mode Host Read operations.   SAM L11   X    SERCOM I <sup>2</sup> C   Client Mode with DMA   2.10.6   Character lost in I <sup>2</sup> C Client mode with DMA when a NACK occurs.   SAM L11   X    SERCOM I <sup>2</sup> C   Client mode 10-bit   2.10.7   I <sup>2</sup> C Client mode with DMA when a NACK occurs.   SAM L10   X    SAM L11   X   SAM L11   X    SERCOM I <sup>2</sup> C   Status Flags   2.10.8   BUSERR, COLL, LOWTOUT, SEXTTOUT and LENERR Status register   SAM L10   X    SAM L11   X   SAM L11   X    SAM L1	RIC	ramper Detection	2.9.9	_	SAM L11	X	
RTC General Purpose Registers 2.9.11 General Purpose Registers n (GPn) are reset on tamper detection even if GPTRST = 0.  Active Layer Protection 2.9.12 When the RTC is configured in Active Layer Protection mode (TAMPCTRL.INACT = 0x3) and the RTC CTRLA.ENABLE bit is not set, a tamper can be detected and at immestamp capture. The TAMPID register and INTFLAG.TAMPER bit may not be set.  SERCOM I <sup>2</sup> C High-speed mode 2.10.1 When configured in HS or Fast-Mode Plus, SDA and SCL fall times are shorter than I <sup>2</sup> C specification requirement and can lead to reflection.  SERCOM I <sup>2</sup> C Repeated start 2.10.2 Bus error is generated during a Repeated Start (when QCEN = 1 and SCLSM = 1).  SERCOM I <sup>2</sup> C Repeated Start / Host mode 10-bit 2.10.3 Repeated Start in 10-bit addressing mode for Host Write operations does not work.  SERCOM I <sup>2</sup> C Repeated Start / Host mode 10-bit 2.10.4 Repeated Start is not supported for High-Speed mode Host Read operations.  SERCOM I <sup>2</sup> C Client Mode with DMA 2.10.5 Repeated Start is not supported for High-Speed mode Host Write operations.  SERCOM I <sup>2</sup> C Client Mode with DMA 2.10.6 Character lost in I <sup>2</sup> C Client mode with DMA when a NACK occurs.  SERCOM I <sup>2</sup> C Client mode 10-bit 2.10.7 I <sup>2</sup> C Client mode with DMA when a NACK occurs.  SERCOM I <sup>2</sup> C Client mode 10-bit X SAML11 X	RTC	Tamper Detection	2.9.10		SAM L10	X	
Registers Registers Registers Registers (1,247) are reset on tamper detection even if GPTRST = 0.  Registers Registers Registers (1,247) are reset on tamper detection even if GPTRST = 0.  Active Layer Protection 2.9.12 When the RTC is configured in Active Layer Protection mode (TAMPCTRL.INACT = 0x3) and the RTC CTRLA.ENABLE bit is not set, a tamper can be detected and a timestamp captured. The TAMPID register and INTFLAG.TAMPER bit may not be set.  SAM L11 X  SERCOM I <sup>2</sup> C High-speed mode 2.10.1 When configured in HS or Fast-Mode Plus, SDA and SCL fall times are shorter than I <sup>2</sup> C specification requirement and can lead to reflection.  SAM L10 X  SERCOM I <sup>2</sup> C Repeated start / Host mode 10-bit 2.10.3 Repeated Start in 10-bit addressing mode for Host Write operations does not work.  SERCOM I <sup>2</sup> C Repeated Start / Host mode 10-bit 2.10.4 Repeated Start is not supported for High-Speed mode Host Read operations.  SERCOM I <sup>2</sup> C Repeated Start / High-Speed mode 2.10.5 Repeated Start is not supported for High-Speed mode Host Write operations.  SERCOM I <sup>2</sup> C Client Mode with DMA 2.10.6 Character lost in I <sup>2</sup> C Client mode with DMA when a NACK occurs.  SERCOM I <sup>2</sup> C Client mode 10-bit 2.10.7 I <sup>2</sup> C Client 10-bit addressing mode is not functional.  SERCOM I <sup>2</sup> C Status Flags 2.10.8 BUSERR, COLL, LOWTOUT, SEXTTOUT and LENERR Status register Site and site in the part to the part of the		,		OUTn pins.	SAM L11	X	
Registers  Registers  Registers  Replace Sam L11	RTC		2.9.11	9 11	SAM L10	X	
Active Layer Protection  2.9.12 (TAMPCTRL INACT = 0x3) and the RTC CTRLA.ENABLE bit is not set, a tamper can be detected and a timestamp captured. The TAMPID register and INTFLAG.TAMPER bit may not be set.  SAM L11 X  SERCOM I <sup>2</sup> C High-speed mode  2.10.1 When configured in HS or Fast-Mode Plus, SDA and SCL fall times are shorter than I <sup>2</sup> C specification requirement and can lead to reflection.  SERCOM I <sup>2</sup> C Repeated start  2.10.2 Bus error is generated during a Repeated Start (when QCEN = 1 and SCLSM = 1).  SERCOM I <sup>2</sup> C Repeated Start / Host mode 10-bit  2.10.3 Repeated Start in 10-bit addressing mode for Host Write operations does not work.  SERCOM I <sup>2</sup> C Repeated Start / Host mode 10-bit  SERCOM I <sup>2</sup> C Repeated Start / Host mode 10-bit  SERCOM I <sup>2</sup> C Repeated Start / High-speed mode Host Read operations.  SERCOM I <sup>2</sup> C Client Mode with DMA  2.10.6 Character lost in I <sup>2</sup> C Client mode with DMA when a NACK occurs.  SERCOM I <sup>2</sup> C Client mode 10-bit  SERCOM I <sup>2</sup> C Status Flags  2.10.8 BUSERR, COLL, LOWTOUT, SEXTTOUT and LENERR Status register  SAM L10 X  SAM L11 X  SERCOM I <sup>2</sup> C Status Flags  2.10.8 BUSERR, COLL, LOWTOUT, SEXTTOUT and LENERR Status register		Registers		GPTRST = 0.	SAM L11	X	
Active Layer Protection 2.9.12 tamper can be detected and a timestamp captured. The TAMPID register and INTFLAG.TAMPER bit may not be set.  SERCOM I <sup>2</sup> C High-speed mode 2.10.1 When configured in HS or Fast-Mode Plus, SDA and SCL fall times are shorter than I <sup>2</sup> C specification requirement and can lead to reflection.  SERCOM I <sup>2</sup> C Repeated start 2.10.2 Bus error is generated during a Repeated Start (when QCEN = 1 and SCLSM = 1).  SERCOM I <sup>2</sup> C Repeated Start / Host mode 10-bit 2.10.3 Repeated Start in 10-bit addressing mode for Host Write operations does not work.  SERCOM I <sup>2</sup> C Repeated Start / Host mode 10-bit 2.10.4 Repeated Start is not supported for High-Speed mode Host Read operations.  SERCOM I <sup>2</sup> C Repeated Start / High-Speed mode Host Write operations.  SERCOM I <sup>2</sup> C Client Mode with DMA 2.10.6 Character lost in I <sup>2</sup> C Client mode with DMA when a NACK occurs.  SERCOM I <sup>2</sup> C Client mode 10-bit 2.10.7 I <sup>2</sup> C Client 10-bit addressing mode is not functional.  SERCOM I <sup>2</sup> C Status Flags 2.10.8 BUSERR, COLL, LOWTOUT, SEXTTOUT and LENERR Status register						SAM L10	X
SERCOM I <sup>2</sup> C High-speed mode 2.10.1 When collapse in high rest-whose Plays, SDA and SCL fall tilles are shorter than I <sup>2</sup> C specification requirement and can lead to reflection.  SERCOM I <sup>2</sup> C Repeated start 2.10.2 Bus error is generated during a Repeated Start (when QCEN = 1 and SCLSM = 1).  SERCOM I <sup>2</sup> C Repeated Start / Host mode 10-bit 2.10.3 Repeated Start in 10-bit addressing mode for Host Write operations does not work.  SERCOM I <sup>2</sup> C Repeated Start / Host mode 10-bit 2.10.4 Repeated Start is not supported for High-Speed mode Host Read operations.  SERCOM I <sup>2</sup> C Repeated Start / High-Speed mode  SERCOM I <sup>2</sup> C Client Mode with DMA 2.10.6 Character lost in I <sup>2</sup> C Client mode with DMA when a NACK occurs.  SERCOM I <sup>2</sup> C Client mode 10-bit 2.10.7 I <sup>2</sup> C Client node with DMA when a NACK occurs.  SERCOM I <sup>2</sup> C Status Flags 2.10.8 BUSERR, COLL, LOWTOUT, SEXTTOUT and LENERR Status register bits not supported for high-speed mode.  SAM L10 X  SAM L11 X  SAM L11 X  SAM L10 X  SAM L11 X	RTC	Active Layer Protection	2.9.12	tamper can be detected and a timestamp captured. The TAMPID register	SAM L11	х	
SERCOM I <sup>2</sup> C  Repeated Start / Host mode 10-bit  SERCOM I <sup>2</sup> C  Repeated Start / Host mode 10-bit  SERCOM I <sup>2</sup> C  Repeated Start / Host mode 10-bit  SERCOM I <sup>2</sup> C  Repeated Start / Host mode 10-bit  SERCOM I <sup>2</sup> C  Repeated Start / Host mode 10-bit  SERCOM I <sup>2</sup> C  Repeated Start / Host mode 10-bit  SERCOM I <sup>2</sup> C  Repeated Start / Host mode 10-bit  SERCOM I <sup>2</sup> C  Repeated Start / High-Speed mode Host Read operations.  Repeated Start is not supported for High-Speed mode Host Write operations.  SERCOM I <sup>2</sup> C  Repeated Start / High-Speed mode  SERCOM I <sup>2</sup> C  Repeated Start / High-Speed mode  SERCOM I <sup>2</sup> C  Client Mode with DMA  2.10.6  Character lost in I <sup>2</sup> C Client mode with DMA when a NACK occurs.  SERCOM I <sup>2</sup> C  Client mode 10-bit  SERCOM I <sup>2</sup> C  Status Flags  SAM L10  X  SAM L10  X  SAM L10  X  SAM L11  X  SAM L11  X  SAM L10  X  SAM L11  X  SAM L10  X  SAM L11  X  SAM L10  X  SAM L11  X  SAM L11  X  SAM L11  X  SAM L10  X  SAM L11  X  SAM L10  X  SAM L11  X  SAM L10  X  SAM L	055001120		inh annad made		SAM L10	×	
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SERCOM I <sup>2</sup> C Repeated Start / Host mode 10-bit 2.10.4 Repeated Start is not supported for High-Speed mode Host Read operations.  SERCOM I <sup>2</sup> C Repeated Start / High-Speed mode 10-bit 2.10.5 Repeated Start is not supported for High-Speed mode Host Write operations.  SERCOM I <sup>2</sup> C Repeated Start / High-Speed mode 10-bit 2.10.5 Repeated Start is not supported for High-Speed mode Host Write operations.  SERCOM I <sup>2</sup> C Client Mode with DMA 2.10.6 Character lost in I <sup>2</sup> C Client mode with DMA when a NACK occurs.  SERCOM I <sup>2</sup> C Client mode 10-bit 2.10.7 I <sup>2</sup> C Client 10-bit addressing mode is not functional.  SERCOM I <sup>2</sup> C Status Flags 2.10.8 BUSERR, COLL, LOWTOUT, SEXTTOUT and LENERR Status register bits one not supported for high-Speed mode Host Write operations.  SAM L10 X SAM L11 X SAM L10 X SAM L10 X SAM L10 X	055504120	Donat datas	0.40.0	Bus error is generated during a Repeated Start (when QCEN = 1 and	SAM L10	X	
SERCOM I <sup>2</sup> C Repeated Start / Host mode 10-bit 2.10.4 Repeated Start is not supported for High-Speed mode Host Read operations.  SERCOM I <sup>2</sup> C Repeated Start / Host mode 10-bit 2.10.5 Repeated Start is not supported for High-Speed mode Host Read operations.  SAM L11 X	SERCOM I <sup>2</sup> C	Repeated start	2.10.2	SCLSM = 1).	SAM L11	X	
SERCOM I <sup>2</sup> C Repeated Start / Host mode 10-bit 2.10.4 Repeated Start is not supported for High-Speed mode Host Read operations.  SERCOM I <sup>2</sup> C Repeated Start / High-Speed mode Host Write operations.  SERCOM I <sup>2</sup> C Client Mode with DMA 2.10.6 Character lost in I <sup>2</sup> C Client mode with DMA when a NACK occurs.  SERCOM I <sup>2</sup> C Client mode 10-bit 2.10.7 I <sup>2</sup> C Client 10-bit addressing mode is not functional.  SERCOM I <sup>2</sup> C Status Flags 2.10.8 BUSERR, COLL, LOWTOUT, SEXTTOUT and LENERR Status register bits greened supported for High-Speed mode Host Write operations.  SAM L10 X SAM L11 X	CEDCOM 120	Repeated Start / Host	2.40.2	Repeated Start in 10-bit addressing mode for Host Write operations does	SAM L10	Х	
SERCOM I <sup>2</sup> C Repeated Start / High- Speed mode  2.10.4 Repeated Start is not supported for High-Speed mode Host Write operations.  Repeated Start / High- Speed mode  2.10.5 Repeated Start is not supported for High-Speed mode Host Write operations.  SAM L10 X  SAM L11 X  SAM L10 X  SAM L11 X  SAM L10 X  SAM L11 X  SAM L10 X  SAM L10 X  SAM L11 X  SAM L10 X	SERCUIVI IFC		2.10.3		SAM L11	×	
SERCOM I <sup>2</sup> C Repeated Start / High-Speed mode    SERCOM I <sup>2</sup> C Client Mode with DMA    SERCOM I <sup>2</sup> C Client mode 10-bit    SERCOM I <sup>2</sup> C Client mode 10-bit    SERCOM I <sup>2</sup> C Status Flags    SERCOM I <sup>2</sup> C Status Flags    SAM L11	SEBCOM 12C	Repeated Start / Host	2.10.4	Repeated Start is not supported for High-Speed mode Host Read	SAM L10	×	
SERCOM I <sup>2</sup> C Client Mode with DMA 2.10.6 Character lost in I <sup>2</sup> C Client mode with DMA when a NACK occurs.  SERCOM I <sup>2</sup> C Client mode 10-bit 2.10.7 I <sup>2</sup> C Client 10-bit addressing mode is not functional.  SERCOM I <sup>2</sup> C Status Flags 2.10.8 BUSERR, COLL, LOWTOUT, SEXTTOUT and LENERR Status register bits are not submedicable closed.	SERCON I-C	mode 10-bit	2.10.4	operations.	SAM L11	X	
SERCOM I <sup>2</sup> C Client Mode with DMA 2.10.6 Character lost in I <sup>2</sup> C Client mode with DMA when a NACK occurs.  SAM L11 X  SAM L10 X  SAM L11 X  SAM L10 X  SAM L11 X  SAM L10 X  SAM L11 X  SAM L10 X	SEBCOM 120	Repeated Start / High-	2.40.5	Repeated Start is not supported for High-Speed mode Host Write	SAM L10	X	
SERCOM I <sup>2</sup> C Client Mode with DMA 2.10.6 Character lost in I <sup>2</sup> C Client mode with DMA when a NACK occurs.  SAM L11 X  SERCOM I <sup>2</sup> C Client mode 10-bit 2.10.7 I <sup>2</sup> C Client 10-bit addressing mode is not functional.  SAM L11 X  SAM L11 X  SAM L11 X  SAM L11 X  SERCOM I <sup>2</sup> C Status Flags 2.10.8 BUSERR, COLL, LOWTOUT, SEXTTOUT and LENERR Status register bits are not submedically closted.	JEROUW I-C	Speed mode	2,10,5	operations.	SAM L11	X	
SERCOM I <sup>2</sup> C Client mode 10-bit 2.10.7 I <sup>2</sup> C Client 10-bit addressing mode is not functional.  SAM L10 X  SAM L11 X  SAM L10 X  SAM L11 X  SAM L11 X  SAM L11 X  SAM L11 X	SEBCOM 12C	Client Mode with DNAA	2 10 6	Character last in I2C Client mode with DMA when a NACK	SAM L10	Х	
SERCOM I <sup>2</sup> C Client mode 10-bit 2.10.7 I <sup>2</sup> C Client 10-bit addressing mode is not functional.  SAM L11 X  SERCOM I <sup>2</sup> C Status Flags 2.10.8 BUSERR, COLL, LOWTOUT, SEXTTOUT and LENERR Status register bits are not submedically closed.	SERCOIVI IFC	Client Mode with DMA	2.10.6	Character lost in I <sup>2</sup> C Client mode with DMA when a NACK occurs.	SAM L11	X	
SERCOM I <sup>2</sup> C Status Flags 2.10.8 BUSERR, COLL, LOWTOUT, SEXTTOUT and LENERR Status register bits are not submedically alloged.	SEBCOM 12C	Client mede 10 hit	2 10 7	I <sup>2</sup> C Client 10 hit addressing made is not functional	SAM L10	Х	
SERCOM I <sup>2</sup> C Status Flags 2.10.8 BUSERR, COLL, LOW 1001, SEAT 1001 and ENDERR Status register	SERCOM PC	Client mode 10-bit	2.10.7	I <sup>2</sup> C Client 10-bit addressing mode is not functional.		X	
	SEBCOM 120	Status Flags	2.40.9	BUSERR, COLL, LOWTOUT, SEXTTOUT and LENERR Status register	SAM L10	X	
	SERCOW IFC	Status Flags	Flags 2.10.8	_	SAM L11	Х	

continued					
Module	Feature	Errata Number	Summary	Device	Affected Silicon Revisions B
SERCOM I <sup>2</sup> C	Status Flore	2 10 0	The CLICHOLD Status bit is not read only	SAM L10	X
SERCOM I-C	Status Flags	2.10.9	The CLKHOLD Status bit is not read only.	SAM L11	Х
SERCOM I <sup>2</sup> C	Status Flags	2.10.10	When an unexpected STOP occurs on the I <sup>2</sup> C bus the STATUS.BUSERR & INTFLAG.ERROR bits are set but may not wake the system from sleep	SAM L10	Х
	_		mode.	SAM L11	X
SERCOM I <sup>2</sup> C	Automatic Acknowledge	2.10.11	The I <sup>2</sup> C Client Automatic Acknowledge feature (CTRLB.AACKEN = 1) is	SAM L10	X
	, idiomato, ionio Modgo		not supported when doing a repeated start.	SAM L11	X
SERCOM SPI	Data Preload	2.11.1	In SPI Client mode with Client Data Preload Enabled, the client transmitter may discard some data if the host cannot keep the SPI Select pin low until	SAM L10	X
SERCOM SI I	Data i reload	2.11.1	the end of transmission.	SAM L11	X
SERCOM SPI	Hardware SPI Select	2,11,2	When Hardware SPI Select Control is enabled, the SPI Select (SS) pin	SAM L10	X
SERCOW SPI	Control	2.11.2	goes high after each byte transfer.	SAM L11	X
CERCOM CRI	Olicat Data Dasland	0.44.0	Preloading a new SPI data before going into Standby Sleep mode, may	SAM L10	Х
SERCOM SPI	Client Data Preload	2.11.3	lead to extra power consumption.	SAM L11	Х
OEDOOM ODL	\\\_\	0.44.4	The Data Register Empty (DRE) wake-up interrupt is not de-asserted	SAM L10	Х
SERCOM SPI	Wakeup Interrupt	2.11.4	when the register interrupt is cleared (INTFLAG.DRE=0).	SAM L11	Х
SERCOM	Inverted Bits	0.40.4	The TXINV and RXINV bits in the CTRLA register have inverted functionality.		Х
USART	Inverted Bits	2.12.1			X
SERCOM	ICO704C Mada	2.12.2	In ISO7816 mode, the SERCOM bus clock continues to run in Stand-by		Х
USART	ISO7816 Mode	2.12.2	Sleep mode causing an extra power consumption.	SAM L11	Х
SERCOM	Debug Mede	2.12.3	Debug made is not functional	SAM L10	Х
USART	Debug Mode	2.12.3	Debug mode is not functional.	SAM L11	X
SERCOM	Collision Detection	2.12.4	Callisian Detection does not stan Data Transfer	SAM L10	Х
USART	Collision Detection	2.12.4	Collision Detection does not stop Data Transfer.	SAM L11	X
SERCOM	Wakaun	2.12.5	The USART does not wake up the device on Error (INTFLAG.ERROR=1)	SAM L10	X
USART	Wakeup	2.12.3	interrupt.	SAM L11	Х
SERCOM	Overconsumption in	2.42.6	Unconceted over consumption in standby made	SAM L10	Х
USART	Standby Mode	2.12.6	Unexpected over-consumption in standby mode	SAM L11	X
SERCOM	Wakeup Interrupt	2.12.7	The Data Register Empty (DRE) wake-up interrupt is not de-asserted	SAM L10	Х
USART	wakeah lillellahi	2.12.1	when the register interrupt is cleared (INTFLAG.DRE = 0).	SAM L11	х
TC	Flags Synchronization	2,13,1	The SYNCBUSY.PER/SYNCBUSY.CCx flags are released before the	SAM L10	X
10	r lage Cynonionization	2,10,1	PERBUF/CCBUFx registers are restored to their expected value.	SAM L11	Х
TC	Capture mode / Over	2.13.2	Over consumption in Capture mode when entering Standby mode.		Х
10	consumption 2.13.2 Over consumption in Capture mode when er		5.57 consumption in capture mode when entering standay mode.	SAM L11	Х
TC	Retrigger	2.13.3	If a Retrigger event occurs at the Channel Compare Match [n] time, the	SAM L10	х
10	Neurgger	2.13.3	next Waveform Output [n] is missing or disturbed.	SAM L11	X
TC	PER Register (8-bit	2.13.4	In 8-bit Mode, PER register updates using the DMA are not possible in	SAM L10	Х
IC	mode)	2.10.4	standby mode.	SAM L11	X

continued	continued								
Module	Feature	Errata Number	Summary	Device	Affected Silicon Revisions B				
			When TRNG is disabled, some internal logic could continue to operate	SAM L10	X				
TRNG	Over consumption	2.14.1	causing an over consumption.	SAM L11	Х				
CUDO	Buck Converter Mode	2.15.1	Digital Phase-Locked Loop FDPLL96M cannot be used with main voltage	SAM L10	Х				
SUPC	Buck Converter Mode	2.15.1	regulator in Buck Converter mode.	SAM L11	Х				
OSC32KCTRL	External 32.768KHz	2.16.1	External 32.768KHz crystal oscillator operation is not supported over the	SAM L10	Х				
OOO52NOTILE	Crystal Oscillator	2.10.1	full temperature range of -40°C to +125°C.	SAM L11	Х				
OSC32KCTRL	1024 Hz Clock Output	4 Hz Clock Output 2.16.2 1024 Hz clock output spikes can lead to wrong RTC or Watchdog	SAM L10	Х					
COOCINGTILE	1024 TIZ Oldok Gutput	2.10.2	counting.	SAM L11	Х				
OSC32KCTRL	Clock Failure Detection	2.16.3	Re-enabling the Clock Failure Detector when the XOSC32K is enabled	SAM L10	Х				
- COOLING TILE	Sicol Fallaro Bolocion	2.10.0	can lead to a false Clock Failure Detection.	SAM L11	X				
OSC32KCTRL	XOSC32K Ready bit	2.16.4	The XOSC32K Ready bit of the STATUS register is not cleared when	SAM L10	Х				
OGGOZIKO ITKE	ACCOSENTICACY BIL	2.10.4	disabling the XOSC32K bit at the same time as the Crystal Oscillator	SAM L11	Х				
Boot ROM	GCM API	GCM API	GCM API	2.17.1	GCM API does not follow the Procedure Call Standard for the ARM	SAM L10			
Bootitow	COW 7 II 1	2.11.1	Architecture (AAPCS)	SAM L11	X				
EVSYS	Synchronous and	•	•	2.18.1	Spurious Overrun Interrupt following a software event.	SAM L10	Х		
24010	Resynchronized Modes	2.10.1	opulious evenui interrupt following a software event.	SAM L11	X				
EVSYS	Synchronous Mode	2.18.2	Spurious Overrun Interrupt when the generic clock for a channel is always	SAM L10	Х				
LVOTO	Synthionous Mode	2.10.2	on.	SAM L11	Х				
FVeVe	Carrierra Orrana	2.40.2	Overrun interrupt flag may be incorrectly set upon software events in	SAM L10	Х				
EVSYS	Spurious Overrun	2.18.3	synchronous/resynchronized path modes with event detection on both rising and falling edges.	SAM L11	X				
EVOVO	Ooftware Frank	0.40.4	CHBUSY flag never reset upon software events in synchronous/ resynchronized path modes with event detection on falling edges.	SAM L10	Х				
EVSYS	Software Event	2.18.4		SAM L11	Х				
E) (0) (0	DAG Meite Bustostion	0.40.5	PAC Write-Protection is not functional for the NSCHKCHAN and	SAM L10	Х				
EVSYS	PAC Write-Protection	2.18.5	NSCHKUSER registers.	SAM L11	Х				
COCCEPI		0.40.4	When the XOSC Clock Failure Detector is enabled and a failure is	SAM L10	Х				
OSCCTRL	Clock Failure Detection	2.19.1	detected, the XOSC Ready bit is not cleared.	SAM L11	Х				
0000701	01 15 11 5 1 1	0.40.0	Re-enabling the Clock Failure Detector when the XOSC is enabled can	SAM L10	Х				
OSCCTRL	Clock Failure Detection	2.19.2	lead to a false Clock Failure Detection.	SAM L11	Х				
OCCUTE	VOCO Desil Di	2.40.0	The XOSC Ready bit of the STATUS register is not cleared when disabling	SAM L10	Х				
OSCCTRL	XOSC Ready Bit	2.19.3	the XOSC at the same time as the Crystal Oscillator.	SAM L11	Х				
0000771	FDPLL96M On Demand	0.40.4	The FDPLL96M On Demand mode is not functional in Standby sleep mode.		Х				
OSCCTRL	in Standby	2.19.4			Х				
000075	DFLLULP Dithering	0.40.5	DELLIN D. C	SAM L10	Х				
OSCCTRL	Mode	2.19.5	DFLLULP dithering mode is not functional.		Х				
DOST	IODUG	0.00.4	Concurrent accesses on the PORT peripheral registers between the ARM	SAM L10	Х				
PORT	IOBUS	2.20.1	APB and the ARM CPU IOBUS are not supported.	SAM L11	Х				

# SAM L10/L11 Family

# Silicon Issue Summary

continued								
Module	Module Feature Errata Number		Summary	Device	Affected Silicon Revisions			
					В			
TDAM	DAO Bastastias	2.21.1		SAM L10	X			
TRAM	PAC Protection		Security RAM n registers (RAMn) are not PAC Write-Protected.		X			
NVMCTRL	Data FLASH Silent	2.22.1	Silent Access and Scrambling on the Data FLASH are not functional when both are enabled.					
IVVIIIOTILE	Access and Scrambling				X			
	Random Hardfaults in Waking		Due to a bug in the NVMCTRL, the user may experience random	SAM L10	Х			
NVMCTRL		2 22 2	hardfaults when dealing with wake up interrupts and IDLE mode (no problem in STANDBY)		X			

### 2. SAM L10/L11 Errata Issues

The following issues apply to the SAM L10/L11 Family devices.

## 2.1 Analog-to-Digital Converter (ADC)

### 2.1.1 Reference Buffer Offset Compensation

TUE of the ADC conversion result is out of specification when,

- Using the reference source as REFCTRL.REFSEL ≠ VDDANA and
- Reference Buffer Offset Compensation is enabled (REFCTRL.REFCOMP = 1)

#### Workaround

The first five conversions after enabling ADC must be ignored. All further ADC conversions are within the specification.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	X			

### 2.1.2 Offset Correction

Offset correction using the OFFSETCORR register is not supported in the 8-bit and 10-bit conversion resolution.

#### Workaround

None.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	X			

#### 2.1.3 SEQSTATE

The SEQSTATUS register is not updated properly when exiting Standby mode by an ADC conversions sequence event. The first conversion source is done (available in the RESULT register), but is not identified and reported in the SEQSTATUS register.

### Workaround

None.

Device Family	В			
SAM L10	X			

continued											
Device Family	В										
SAM L11	Х										

#### **Configurable Custom Logic (CCL)** 2.2

#### 2.2.1 **PAC Protection**

Writing the Software Reset bit in the Control A register (CTRLA.SWRST) will trigger a PAC protection error.

Clear the CCL PAC error each time a CCL software reset is executed.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L1	0 X			
SAM L1	1 X			

#### 2.2.2 **Enable Protected Registers**

The SEQCTRL0 and LUCTRL0/1 registers are enable-protected by the CTRL.ENABLE bit whereas they should be enable-protected by the LUTCTRL0/1.ENABLE bits.

#### Workaround

None.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	X			

#### 2.2.3 **Sequential Logic**

LUT Output is corrupted after enabling CCL when sequential logic is used.

#### Workaround

Write the CTRL register twice when enabling the CCL.

#### Affected Silicon Revisions

Device Family	В			
SAM L10	X			
SAM L11	X			

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### 2.3 DEVICE

### 2.3.1 Temperature Sensor

Temperature Sensor is not functional.

#### Workaround

None.

#### Affected Silicon Revisions

Device Family	В			
SAM L10	X			
SAM L11	X			

### 2.3.2 Standby Entry

When the Systick interrupt is enabled and the standby back-bias option is set (STDBYCFG.BBIAS = 1), a hard fault can occur when the Systick interrupt coincides with the standby entry.

### Workaround

Disable the Systick interrupt before entering standby and re-enable it after wake up.

#### **Affected Silicon Revisions**

Devic Fami	e ly	В			
SAM L	.10	X			
SAM L	.11	Х			

## 2.4 Direct Memory Access Controller (DMAC)

### 2.4.1 Concurrent Channels Trigger

When using concurrent channels triggers, DMAC write-back descriptors may get corrupted.

#### Workaround

Multiple transfers must only be sequenced using linked descriptors on a single channel.

Device Family	В			
SAM L10	X			
SAM L11	Х			

## 2.5 External Interrupt Controller (EIC)

### 2.5.1 PAC Protection

8-bit and 16-bit reads/writes on the reserved areas of the EIC registers mapping starting from the EVCTRL register do not generate a PAC protection error.

#### Workaround

None.

#### **Affected Silicon Revisions**

De Fai	vice mily	В			
SAN	Л L10	Х			
SAN	Л L11	Х			

## 2.6 Frequency Meter (FREQM)

#### 2.6.1 PAC Protection

FREQM reads on the Control B register (FREQM.CTRLB) generate a PAC protection error.

#### Workaround

None.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	X			

## 2.7 Main Clock (MCLK)

#### 2.7.1 PAC Protection

Writes to the MCLK Control A register (MCLK.CTRLA) do not generate a PAC protection error even if this register has been write-protected using the PAC.

#### Workaround

None.

Device Family	В			
SAM L10	X			
SAM L11	Х			

### 2.7.2 DFLLULP Clock

A Hard fault exception can occur after selecting the DFLLULP clock as main clock source (CTRLA.CKSEL = 1).

#### Workaround

Add 6 NOP instructions after writing the CTRAL.CKSEL bit.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	X			

## 2.8 Operational Amplifier Controller (OPAMP)

#### 2.8.1 Reference Buffer

The internal reference REFBUF is not generated when the Low-Power Mux feature is enabled (CTRLA.LPMUX = 1).

#### Workaround

Disable the Low-Power Mux feature (CTRLA.LPMUX = 0) when the internal REFBUF is used.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	Х			

### 2.8.2 High Gain Instrumentation Amplifier

High Gain Instrumentation Amplifier is not functional.

### Workaround

None.

Device Family	В			
SAM L10	X			
SAM L11	Х			

#### 2.9 Real Time Clock (RTC)

#### 2.9.1 **Tamper Detection**

When the RTC Separate Tamper Outputs (SEPTO) bit of the CTRLB register is cleared (CTRLB.SEPTO = 0) and the Active layer protection 0 (ALSI0) bit of the TAMPCTRLB register is set (TAMCTRLB.ALSI0 = 1), the RTC pseudo random pattern is only generated on the TrustRAM Active layer.

#### Workaround

Set the CTRLB.SEPTO bit to '1' if Tamper Detection is required on the RTC Tamper pins.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	X			

#### 2.9.2 **Event Generation**

In RTC Clock mode or Calendar mode (CTRLA.MODE = 2), the Periodic Daily Event (PERD) is not generated.

#### Workaround

None.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	X			

#### 2.9.3 **Write Corruption**

A 8-bit or 16-bit write access for a 32-bit register, or 8-bit write access for a 16-bit register can fail for the following registers:

- The COUNT register in COUNT32 mode
- The COUNT register in COUNT16 mode
- The CLOCK register in CLOCK mode

#### Workaround

Write the registers with:

- A 32-bit write access for:
  - The COUNT register in COUNT32 mode
  - The CLOCK register in CLOCK mode
- · A 16-bit write access for:
  - The COUNT register in COUNT16 mode

Device Family	В			
SAM L10	X			
SAM L11	X			

#### 2.9.4 **Tamper Detection Timestamp**

If an external reset occurs during a tamper detection, the TIMESTAMP register will not be updated when next tamper detection is triggered.

#### Workaround

Enable RTC tamper interrupt and copy the timestamp from the RTC CLOCK register to one of the following locations:

- GPx register in RTC

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	Х			

#### 2.9.5 **Prescaler**

When the tamper or debouncing features (TAMPCTRL) are enabled, periodic interrupts and events are generated when the prescaler is OFF (CTRLA.PRESCALER = 0).

#### Workaround

When the prescaler is OFF (CTRLA.PRESCALER = 0), clear the Periodic Interval n Event Output Enable bits (EVCTRL.PEREOn [n = 7...0]) and the respective Periodic Interval n Interrupt Enable (INTENCLR.PERn [n = 7...0]) bits.

#### Affected Silicon Revisions

Device Family	В			
SAM L10	X			
SAM L11	Х			

#### 2.9.6 **Active Layer Protection**

Active Layer Protection feature is limited to one tamper channel n (i.e. one RTC INn/OUTn pair). Any other tamper channels can be used either in Wake mode or Capture mode.

#### Workaround

None.

Device Family	В			
SAM L10	X			
SAM L11	X			

#### 2.9.7 Tamper Detection Timestamp

The INTFLAG.TAMPER bit is not reset by reading the TIMESTAMP register.

#### Workaround

Clear the INTFLAG.TAMPER bit by writing a '1' to this bit when the Timestamp value has been read from the TIMESTAMP register.

#### Affected Silicon Revisions

Device Family	В			
SAM L10	Х			
SAM L11	X			

#### 2.9.8 Tamper Detection Timestamp

A wrong timestamp value can be returned if more than one CPU and DMA accesses to the TIMESTAMP register are performed upon a INTFLAG.TAMPER assertion.

#### Workaround

The timestamp value captured in the TIMESTAMP register must be retrieved as described below:

- If RTC can trigger a DMA request when the timestamp value is available (CTRLB.DMAEN = 1):
  - Wait for DMA transfer completion to read the timestamp value from the DMA buffers.
  - Clear the INTFLAG.TAMPER bit.

Note: Do not read the timestamp value from the TIMESTAMP register.

- If RTC cannot trigger a DMA request when the timestamp value is available (CTRLB.DMAEN = 0):
  - Wait for the INTFLAG.TAMPER bit to read the timestamp value from the TIMESTAMP register.
  - Clear the INTFLAG.TAMPER bit.

### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	X			

### 2.9.9 Tamper Detection

If the Tamper Channel n Action (TAMPCTRL.INnACT) is set to WAKE or CAPTURE and the Active Layer Protection is enabled for this channel (TAMPCTRLB.ALSIn = 1), no tampers are detected on this channel n.

### Workaround

Clear the TAMPCTRLB.ALSIn bits for the channels configured in WAKE or CAPTURE modes.

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Device Family	;	В			
SAM L1	0	Χ			
SAM L1	1	Х			

#### 2.9.10 **Tamper Detection**

False tamper detections may occur when configuring the RTC INn and OUTn pins.

#### Workaround

First configure the different RTC registers, and then select the RTC INn and OUTn peripheral functions on the PORT peripheral (PMUX registers).

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	Х			

#### 2.9.11 **General Purpose Registers**

The General Purpose Registers n (GPn) are reset on tamper detection even if GPTRST = 0.

#### Workaround

None.

#### Affected Silicon Revisions

De <sup>s</sup> Fai	vice mily	В			
SAM	1 L10	Χ			
SAN	/ L11	Х			

#### 2.9.12 **Active Layer Protection**

When the RTC is configured in Active Layer Protection mode (TAMPCTRL.INACT = 0x3), and the RTC CTRLA.ENABLE bit is not set, a tamper can be detected and a timestamp captured. The TAMPID register and the INTFLAG.TAMPER bit may not be set.

#### Workaround

When the RTC is configured in Active Layer Protection mode, after setting the CTRLA.ENABLE control bit, the user must wait for 10 RTC clock periods. Then the user must clear the TAMPID register and the INTFLAG.TAMPER bit, and do a dummy read of the TIMESTAMP register to remove the lock condition on the TIMESTAMP register.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	X			

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## 2.10 Serial Communication Interface Inter-Integrated Circuit (SERCOM I<sup>2</sup>C)

### 2.10.1 High-Speed Mode

When configured in HS or Fast-Mode Plus, SDA and SCL fall times are shorter than I<sup>2</sup>C specification requirement and can lead to reflection.

#### Workaround

When reflection is observed, a 100 ohm serial resistor can be added on the impacted line.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	Х			

#### 2.10.2 Repeated Start

When Quick command is enabled (CTRLB.QCEN = 1), the software can issue a Repeated Start by either writing the CTRLB.CMD or ADDR.ADDR bit fields. If in these conditions, SCL Stretch Mode is CTRLA.SCLSM = 1, a bus error will be generated.

#### Workaround

Use Quick Command mode (CTRLB.QCEN = 1) only if SCL Stretch mode is CTRLA.SCLSM = 0.

### **Affected Silicon Revisions**

ı	Device Family	В			
	SAM L10	Х			
	SAM L11	Х			

### 2.10.3 Repeated Start

For Host Write operations (excluding High-Speed mode), in 10-bit addressing mode, writing CTRLB.CMD = 0x1 does not issue correctly a Repeated Start command.

#### Workaround

Write the same 10-bit address with the same direction bit to the ADDR.ADDR register to generate properly a Repeated Start.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	X			

### 2.10.4 Repeated Start

For High-Speed Host Read operations, sending a NACK (CTRLB.CMD = 0x2) forces a STOP to be issued making repeated start not possible in that mode.

#### Workaround

None.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	X			

### 2.10.5 Repeated Start

For High-Speed Host Write operations, writing CTRLB.CMD = 0x1 issues a STOP command instead of a Repeated Start making repeated start not possible in that mode.

#### Workaround

None.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	Х			

#### 2.10.6 Client Mode with DMA

In I<sup>2</sup>C Client Transmitter mode, at the reception of a NACK, if there is still data to be sent in the DMA buffer, the DMA will push a data to the DATA register. Because a NACK was received, the transfer on the I<sup>2</sup>C bus will not occur causing the loss of this data.

#### Workaround

Configure the DMA transfer size to the number of data to be received by the I<sup>2</sup>C host. DMA cannot be used if the number of data to be received by the host is not known.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	X			

### 2.10.7 Client Mode 10-bit

I<sup>2</sup>C client 10-bit addressing mode is not functional.

### Workaround

None.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			

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continu	continued										
Device Family	В										
SAM L11	X										

### 2.10.8 Status Flags

In Client mode, the BUSERR, COLL, LOWTOUT, SEXTTOUT and LENERR STATUS register bits are not automatically cleared when INTFLAG.AMATCH is cleared.

#### Workaround

Clear the STATUS register bits, BUSERR, COLL, LOWTOUT, SEXTTOUT and LENERR, by writing these STATUS bits to '1' when INTFLAG.AMATCH is cleared.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	Х			

### 2.10.9 Status Flags

The STATUS.CLKHOLD bit in host and client modes can be written whereas it is a read-only status bit.

#### Workaround

Do not clear the STATUS.CLKHOLD bit to preserve the current clock hold state.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	Х			

### 2.10.10 Status Flags

When an unexpected STOP occurs on the  $I^2$ C bus, the STATUS.BUSERR and INTFLAG.ERROR bits are set, but may not wake the system from Sleep mode. An unexpected START will not produce this issue.

### Workaround

None.

### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	Х			

### 2.10.11 Automatic Acknowledge

The I<sup>2</sup>C Client Automatic Acknowledge feature (CTRLB.AACKEN = 1) is not supported when doing a repeated start.

#### Workaround

Do not use the AACKEN feature, implement a AMATCH handler instead.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	X			

## 2.11 Serial Communication Serial Peripheral Interface (SERCOM SPI)

### 2.11.1 Data Preload

In SPI Client mode with Client Data Preload Enabled (CTRLB.PLOADEN = 1), the client transmitter may discard some data if the host cannot keep the SPI Select ( $\overline{SS}$ ) pin low until the end of transmission.

#### Workaround

In SPI Client mode, the SPI Select  $(\overline{SS})$  pin must be kept low by the host until the end of the transmission if the Client Data Preload feature is used (CTRLB.PLOADEN = 1).

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	X			

### 2.11.2 Hardware SPI Select Control

When Hardware SPI Select Control is enabled (CTRLB.MSSEN = 1), the SPI Select ( $\overline{SS}$ ) pin goes high after each byte transfer even if a new data is ready to be sent.

### Workaround

Set CTRLB.MSSEN = 0 and handle the SPI Select ( $\overline{SS}$ ) pin by software.

#### Affected Silicon Revisions

Device Family	В			
SAM L10	X			
SAM L11	X			

#### 2.11.3 Client Data Preload

Preloading a new SPI data (CTRLB.PLOADEN = 1) before going into Standby mode, may lead to extra power consumption.

#### Workaround

None.

Device Family	В			
SAM L10	X			
SAM L11	X			

### 2.11.4 Wake-up Interrupt

The Data Register Empty (DRE) wake-up interrupt is not de-asserted when the register interrupt is cleared (INTFLAG.DRE = 0).

The issue occurs if the DRE interrupt is enabled (INTSET.DRE = 1) when the device enters in Standby mode.

#### Workaround

Write DATA register before going back to Standby mode.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	X			

### 2.12 Serial Communication Interface USART (SERCOM USART)

#### 2.12.1 Inverted Bits

The TXINV and RXINV bits in the CTRLA register have inverted functionality.

#### Workaround

In software, interpret the TXINV bit as a functionality of RXINV, and conversely, interpret the RXINV bit as a functionality of TXINV.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	X			

#### 2.12.2 ISO7816 Mode

When the SERCOM USART is in ISO7816 mode, the SERCOM bus clock continues to run in Standby mode causing extra power consumption.

#### Workaround

Disable the USART before entering Standby mode.

Device Family	В			
SAM L10	Х			
SAM L11	X			

#### 2.12.3 **Debug Mode**

In USART operating mode, if DBGCTRL.DBGSTOP = 1, data transmission is not halted when entering Debug mode.

#### Workaround

None.

#### Affected Silicon Revisions

Device Family	В			
SAM L10	X			
SAM L11	Х			

#### 2.12.4 **Collision Detection**

In USART operating mode with Collision Detection enabled (CTRLB.COLDEN = 1), the SERCOM will not abort the current transfer as expected if a collision is detected and if the SERCOM APB clock is lower than the SERCOM generic clock.

#### Workaround

The SERCOM APB clock must always be higher than the SERCOM generic clock to support collision detection.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	Х			
SAM L11	Х			

#### 2.12.5 Wakeup

The USART does not wake up the device on Error Interrupt (INTFLAG.ERROR = 1).

#### Workaround

Configure the USART to wake up the device on the RX Complete Interrupt (INTENSET.RXC = 1) to check the PERR/FERR status (STATUS.PERR = 1 or STATUS.FERR = 1).

### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	Х			

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### 2.12.6 Overconsumption in Standby Mode

When SERCOM USART CTRLA.RUNSTDBY = 0 and the Receiver is disabled (CTRLB.RXEN = 0), the clock request to the GCLK generator feeding the SERCOM will stay asserted during Standby mode, leading to unexpected overconsumption.

#### Workaround

Configure CTRLA.RXPO and CTRLA.TXPO to use the same SERCOM PAD for RX and TX, or add an external pull-up on the RX pin.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	X			

### 2.12.7 Wake-up Interrupt

The Data Register Empty (DRE) wake-up interrupt is not de-asserted when the register interrupt is cleared (INTFLAG.DRE = 0).

The issue occurs if the DRE interrupt is enabled (INTSET.DRE = 1) when the device enters in Standby mode.

#### Workaround

Write DATA register before going back to Standby mode.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	X			

## 2.13 Timer Counter (TC)

#### 2.13.1 Flags Synchronization

When clearing the STATUS.PERBUFV/STATUS.CCBUFVx flags, the SYNCBUSY.PER/SYNCBUSY.CCx flags are released before the PERBUF/CCBUFx registers are restored to their expected value.

#### Workaround

Successively, clear the STATUS.PERBUFV/STATUS.CCBUFVx flags twice to ensure that the PERBUF/CCBUFx registers value is properly restored before updating it.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	Х			

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### 2.13.2 Capture Mode / Over consumption

If the Time Counter x (TCx) is in Capture mode (TC.CTRLA.CAPTENx = 1) and TC.CTRLA.RUNSTBY = 0, the clock source driving GCLK TCx can be kept running in Standby mode causing extra power consumption.

#### Workaround

Disable the Time Counter x (TCx) (TC.CTRLA.ENABLE = 0) which has a channel configured in Capture mode before going to Standby mode.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	Х			

### 2.13.3 Retrigger

If a Retrigger event (EVCTRL.EVACTn = 0x1, RETRIGGER) occurs at the Channel Compare Match [n] time, the next Waveform Output [n] is corrupted.

#### Workaround

Use two channels to store their two successive (n and n+1) CC register values and combine their related waveform outputs to make signal redundancy.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	Х			

#### 2.13.4 PER Register

In 8-bit mode, the PER register updates using the DMA are not possible in Standby mode.

#### Workaround

None.

### **Affected Silicon Revisions**

Device Family	В			
SAM L10	Х			
SAM L11	Х			

## 2.14 True Random Number Generator (TRNG)

### 2.14.1 Over consumption

When TRNG is disabled, some internal logic could continue to operate causing an over consumption.

### Workaround

Disable the TRNG module twice:

- CTRLA.ENABLE = 0;
- CTRLA.ENABLE = 0;

Device Family	В			
SAM L10	X			
SAM L11	X			

### 2.15 Supply Controller (SUPC)

#### 2.15.1 Buck Converter Mode

Buck Converter mode is not supported when using FDPLL96M. As a result, the data provided in Tables 46-8 and 47-2 "Active Current Consumption for Buck converter mode with FDPLL96M at Performance Level 2 (PL2) setting" is not valid and must be disregarded.

#### Workaround

Use the LDO Regulator mode when using FDPLL96M.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	X			

### 2.16 OSC32KCTRL

### 2.16.1 External 32.768 kHz Crystal Oscillator

External 32.768 kHz crystal oscillator operation is not supported over the full temperature range of -40°C to +125°C.

#### Workaround

Limit external 32.768 kHz crystal oscillator operation temperature range from 0°C to 125°C with a crystal ESR <70 k $\Omega$ .

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	X			

### 2.16.2 1024 Hz Clock Output

When the XOSC32K is configured for 1024 Hz clock output and is used to clock the Watchdog (OSCULP32K.ULP32KSW = 1) or the RTC (RTCCTRL.RTCSEL = 4), the 1024 Hz clock can generate spikes in Standby Low-Power mode if the XOSC32K is not always ON, leading to incorrect RTC/WDT counting.

#### Workaround

Set XOSC32K.RUNSTBY = 1 and clear XOSC32K.ONDEMAND = 0 to force the XOSC32K to be always ON in Standby Low-Power mode.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	Х			

#### 2.16.3 **Clock Failure Detection**

Disabling the Clock Failure Detector (CFDCTRL.CFDEN = 0) and re-enabling it (CFDCTRL.CFDEN = 1) when the XOSC32K is enabled (XOSC32K.ENABLE = 1) can lead to a false Clock Failure Detection.

#### Workaround

Re-enable the Clock Failure Detector as follows:

- Disable the XOSC32K (XOSC32K.ENABLE = 0).
- 2. Disable the Clock Failure Detector (CFDCTRL.CFDEN = 0).
- Re-enable the Clock Failure Detector (CFDCTRL.CFDEN = 1).
- Re-enable the XOSC32K (XOSC32K.ENABLE = 1).

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	Х			

#### 2.16.4 XOSC32K Ready Bit

The XOSC32K Read bit of the STATUS register (STATUS, XOSC32KRDY) is not cleared when disabling the XOSC32K (XOSC32K.ENABLE = 0) at the same time as the Crystal Oscillator Enable bit (XOSC32K.XTALEN = 0).

#### Workaround

Disable the XOSC32K as follows:

- Disable the XOSC32K (XOSC32K.ENABLE = 0).
- Disable the Crystal Oscillator (XOSC32K.XTALEN = 0).

### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	Х			

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### 2.17 Boot ROM

### 2.17.1 GCM API

The GCM API function crya\_gf\_mult128\_t does not save and restore the core register r8 on return, thereby violating the Procedure Call Standard for the Arm<sup>®</sup> Architecture (AAPCS).

#### Workaround

The Arm core register r8 must be saved before calling the crya\_gf\_mult128\_t function and must be restored when returning from it.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10				
SAM L11	X			

## 2.18 Event System (EVSYS)

### 2.18.1 Synchronous and Resynchronized Modes

In synchronous or resynchronized modes, generating a software event can generate a spurious overrun interrupt.

#### Workaround

None.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	Х			

### 2.18.2 Synchronous Mode

In Synchronous mode, spurious overrun interrupts can be generated when the generic clock for a channel is always ON (CHANNEL.ONDEMAND = 0).

#### Workaround

Set Generic Clock on Demand feature by setting CHANNEL.ONDEMAND = 1.

#### **Affected Silicon Revisions**

Device Family	e /	В			
SAM L1	0	X			
SAM L1	1	Х			

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#### 2.18.3 **Spurious Overrun**

If a software event occurs when the EVSYS is set in synchronous/resynchronized path modes (CHANNELn.PATH = 0x0/0x1) with event detection set on both rising and falling edges (CHANNELn.EDGESEL = 0x3), spurious overrun interrupts may occur (INTFLAG.OVRn).

#### Workaround

Generate software events for the event user through a dedicated channel configured with even detection set on rising edges (CHANNELn.EDGESEL = 0x1).

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	X			

#### 2.18.4 **Software Event**

If a software event occurs when the EVSYS is set in synchronous/resynchronized path modes (CHANNELn.PATH = 0x0/0x1) with event detection set on falling edges (CHANNELn.EDGESEL = 0x2), the CHSTATUS.CHBUSYn flag will be set but will never come back to 0. It is then impossible to know if the event user for this channel is ready or not to accept new events.

#### Workaround

Generate software events for this user through a dedicated channel configured with even detection set on rising edges (CHANNELn.EDGESEL = 0x1).

### **Affected Silicon Revisions**

Device Family	В			
SAM L10	Х			
SAM L11	Х			

#### 2.18.5 **PAC Write-Protection**

PAC Write-Protection is not functional for the NSCHKCHAN and NSCHKUSER registers.

#### Workaround

None.

#### Affected Silicon Revisions

Device Family	В			
SAM L10	X			
SAM L11	Х			

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### 2.19 Oscillator Controller (OSCCTRL)

#### 2.19.1 Clock Failure Detection

When the XOSC Clock Failure Detector is enabled (XOSCCTRL.CFDEN = 1) and a failure is detected (STATUS.XOSCFAIL = 1), the XOSC Ready bit is not cleared (STATUS.XOSCRDY = 1).

#### Workaround

STATUS.XOSCFAIL must always be checked before STATUS.XOSCRDY, and STATUS.XOSCRDY must always be ignored when STATUS.XOSCFAIL = 1.

#### Affected Silicon Revisions

Device Family	В			
SAM L10	X			
SAM L11	Х			

#### 2.19.2 Clock Failure Detection

Disabling the Clock Failure Detector (XOSCCTRL.CFDEN = 0) and re-enabling it (XOSCCTRL.CFDEN = 1) when the XOSC is enabled (XOSCCTRL.ENABLE = 1) can lead to a false Clock Failure Detection.

#### Workaround

Re-enable the Clock Failure Detector as follows:

- 1. Disable the XOSC (XOSCCTRL.ENABLE = 0).
- 2. Disable the Clock Failure Detector (XOSCCTRL.CFDEN = 0).
- 3. Re-enable the Clock Failure Detector (XOSCCTRL.CFDEN = 1).
- 4. Re-enable the XOSC (XOSCCTRL.ENABLE = 1).

### **Affected Silicon Revisions**

Device Family	В			
SAM L10	Х			
SAM L11	X			

#### 2.19.3 XOSC Ready Bit

The XOSC Read bit of the STATUS register (STATUS.XOSCRDY) is not cleared when disabling the XOSC bit (XOSCCTRL.ENABLE = 0) at the same time as the Crystal Oscillator Enable bit (XOSCCTRL.XTALEN = 0).

#### Workaround

Disable the XOSC Ready bit as follows:

- Disable the XOSC (XOSCCTRL.ENABLE = 0).
- 2. Disable the Crystal Oscillator (XOSCCTRL.XTALEN = 0).

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			

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Ī	continued										
ı	Device Family	В									
	SAM L11	Х									

### 2.19.4 FDPLL96M On Demand in Standby

The FDPLL96M On Demand mode (DPLLCTRLA.ONDEMAND = 1) is not functional in Standby mode.

#### Workaround

Set DPLLCTRLA.ONDEMAND = 0 which makes the FDPLL96M always running in Standby mode.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	Х			

### 2.19.5 DFLLULP Dithering Mode

DFLLULP dithering mode (DFLLULPCTRL.DITHER = 1) is not functional.

#### Workaround

None.

#### Affected Silicon Revisions

Device Family	В			
SAM L10	X			
SAM L11	Х			

## 2.20 PORT I/O Controller (PORT)

#### 2.20.1 IOBUS

Concurrent accesses on the PORT peripheral registers between the Arm APB and the Arm CPU IOBUS are not supported.

#### Workaround

Use exclusively the Arm APB or the Arm CPU IOBUS to access the PORT peripheral registers.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	X			
SAM L11	X			

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#### 2.21 Trust Ram (TRAM)

#### 2.21.1 **PAC Protection**

Security RAM n registers (RAMn) are not PAC Write-Protected.

#### Workaround

None.

#### **Affected Silicon Revisions**

Device Family	В			
SAM L10	) X			
SAM L11	×			

#### 2.22 Non Volatile Memory Controller (NVMCTRL)

#### 2.22.1 **Data Flash Silent Access and Scrambling**

Silent Access and Scrambling on the Data Flash are not functional when both are enabled. Silent Access and Data Flash scrambling remain functional if only one of them is configured by the application.

#### Workaround

None.

#### **Affected Silicon Revisions**

	Device Family	В			
	SAM L10				
	SAM L11	X			

#### 2.22.2 Hardfaults when Waking using Certain Parameters

In the following conditions, upon wake-up, if the instruction following the WFI instruction is not prefetched or cached, CPU read in Flash can be corrupted:

- CPU is in Thread mode (CPU core register PRIMASK = 1)
- CPU is in Idle Sleep mode
- Flash Power Reduction mode is enabled (CTRLB.SLEEPPRM = 0x0 or 0x1)

#### Workaround

Use any one of the following workarounds:

- Disable the Flash Power Reduction mode (CTRLB.SLEEPPRM = 0x3). This will affect the Standby Low-Power mode current consumptions.
- Relocate the WFI critical section in SRAM or in cache

# SAM L10/L11 Family SAM L10/L11 Errata Issues

Device Family	В			
SAM L10	X			
SAM L11	X			

## **Data Sheet Clarifications**

## 3. Data Sheet Clarifications

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet (DS60001513G):

**Note:** Corrections in tables, registers, and texts are shown in **bold**. Where possible, the original bold text formatting has been removed for clarity.

There are currently no data sheet clarifications to report.

## 4. Revision History

#### **Revision F - 03/2022**

Updated the device ID in SAM L10 Family Silicon Device Identification.

The following errata were added in this revision:

- ADC: 2.1.3 SEQSTATE
- NVMCTRL: 2.22.2 Random Hardfaults in Waking

#### Revision E - 07/2021

The SPI, I<sup>2</sup>S, and I<sup>2</sup>C standards use the terminology "Master" and "Slave". The equivalent Microchip terminology used in this document is "Host" and "Client" respectively. These terms have been updated throughout this document for this revision.

This revision contains numerous typographical updates, and formatting updates.

Obsolete Data Sheet Clarifications have been removed in this update.

The following errata were added in this revision:

- RTC: 2.9.12 Active Layer Protection
- SERCOM I<sup>2</sup>C: 2.10.11 Automatic Acknowledge
- TC: 2.13.4 PER register (8-bit mode)
- EVSYS: 2.18.3 Spurious Overrun
- EVSYS: 2.18.4 Software Event
- EVSYS: 2.18.5 PAC Write-Protection
- OSCCTRL: 2.19.4 FDPLL96M On Demand in Standby
- OSCCTRL: 2.19.5 DFLLULP Dithering Mode
- NVMCTRL: 2.22.1 Data FLASH Silent Access and Scrambling

#### Revision D - 01/2021

This revision contains numerous typographical updates, and formatting updates.

The following errata were updated with new verbiage:

- DMAC: 2.4.1 Concurrent Channels Trigger
- EIC: 2.5.1 PAC Protection
- OPAMP: 2.8.1 Reference Buffer
- SERCOM I2C: 2.10.8 Status Flags
- SERCOM I2C: 2.10.9 Status Flags
- SERCOM SPI: 2.11.1 Data Preload
- SERCOM USART: 2.12.5 Wakeup

The following errata were added in this revision:

- ADC: 2.1.2 Offset Correction
- Device: 2.3.2 Standby Entry
- RTC: 2.9.9 Tamper Detection
- RTC: 2.9.10 Tamper Detection
- RTC: 2.9.11 General Purpose Registers
- SERCOM I2C: 2.10.10 Status Flags
- SERCOM SPI: 2.11.2 Hardware Slave Select Control
- SERCOM SPI: 2.11.3 Slave Data Preload
- SERCOM SPI: 2.11.4 Wakeup Interrupt
- SERCOM USART: 2.12.6 Overconsumption in Standby Mode

- SERCOM USART: 2.12.7 Wakeup Interrupt
- TC: 2.13.3 Retrigger
- OSC32KCTRL: 2.16.2 1024 Hz Clock Output
- OSC32KCTRL: 2.16.3 Clock Failure Detection
- OSC32KCTRL: 2.16.4 XOSC32K Ready Bit
- EVSYS: 2.18.1 Synchronous and Resynchronized Modes
- EVSYS: 2.18.2 Synchronous Mode
- OSCCTRL: 2.19.1 Clock Failure Detection
- OSCCTRL: 2.19.2 Clock Failure Detection
- · OSCCTRL: 2.19.3 XOSC Ready Bit
- PORT: 2.20.1 IOBUS
- TRAM: 2,21,1 PAC Protection

#### Revision C - 05/2019

The following new errata were added:

- · RTC:
  - 2.9.5 Prescaler
  - 2.9.6 Active Layer Protection
  - 2.9.7 Tamper Detection Timestamp
  - 2.9.8 Tamper Detection Timestamp
- · SERCOM USART:
  - 2.12.5 Wakeup

#### Revision B - 02/2019

The following new errata were added:

- RTC: 2.9.4 Tamper detection Timestamp
- SUPC: 2.15.1 Buck Converter Mode
- OSC32KCTRL: 2.16.1 External 32.768kHz Crystal Oscillator
- Boot ROM: 2.17.1 GMC API

The following errata is updated:

• ADC: 2.1.1 Reference Buffer Offset Compensation

The following Data Sheet clarifications were added:

- · Updates to Electrical Specifications Tables:
  - Table 46-8
  - Table 46-54
  - Table 47-2

### Revision A - 5/2018

This is the initial release of this document.

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